PBSS4160PANP

60 V, 1 A NPN/PNP low VCEsat (BISS) transistor

20 December 2017 **Product data sheet**

1. General description

NPN/PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

NPN/NPN complement: PBSS4160PAN. PNP/PNP complement: PBSS5160PAP.

2. Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain h_{FE} at high I_C
- Reduced Printed-Circuit Board (PCB) requirements
- High efficiency due to less heat generation
- AEC-Q101 qualified

3. Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

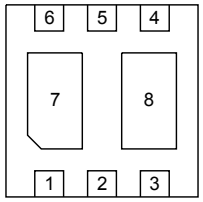
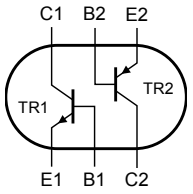
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor; for the PNP transistor with negative polarity							
V_{CEO}	collector-emitter voltage	open base		-	-	60	V
I_C	collector current			-	-	1	A
I_{CM}	peak collector current	single pulse; $t_p \leq$ 1 ms		-	-	1.5	A
TR1 (NPN)							
R_{CEsat}	collector-emitter saturation resistance	I_C = 0.5 A; I_B = 50 mA; $t_p \leq$ 300 µs; pulsed; $\delta \leq$ 0.02 ; T_{amb} = 25 °C		-	-	240	mΩ
TR2 (PNP)							
R_{CEsat}	collector-emitter saturation resistance	I_C = -0.5 A; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; $\delta \leq$ 0.02 ; T_{amb} = 25 °C		-	-	360	mΩ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	 Transparent top view **DFN2020-6 (SOT1118)**	 *sym139*
2	B1	base TR1		
3	C2	collector TR2		
4	E2	emitter TR2		
5	B2	base TR2		
6	C1	collector TR1		
7	C1	collector TR1		
8	C2	collector TR2		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS4160PANP	DFN2020-6	DFN2020-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118

7. Marking

Table 4. Marking codes

Type number	Marking code
PBSS4160PANP	2M

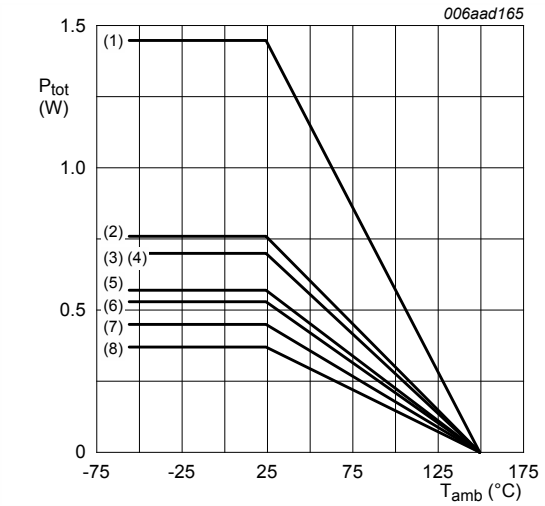
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transistor; for the PNP transistor with negative polarity						
V_{CBO}	collector-base voltage	open emitter		-	60	V
V_{CEO}	collector-emitter voltage	open base		-	60	V
V_{EBO}	emitter-base voltage	open collector		-	7	V
I_C	collector current			-	1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1$ ms		-	1.5	A
I_B	base current			-	0.3	A
I_{BM}	peak base current	single pulse; $t_p \leq 1$ ms		-	1	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	370	mW
			[2]	-	570	mW
			[3]	-	530	mW
			[4]	-	700	mW
			[5]	-	450	mW
			[6]	-	760	mW
			[7]	-	700	mW
			[8]	-	1450	mW
Per device						
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	510	mW
			[2]	-	780	mW
			[3]	-	730	mW
			[4]	-	960	mW
			[5]	-	620	mW
			[6]	-	1040	mW
			[7]	-	960	mW
			[8]	-	2000	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.



(1) 4-layer PCB 70 µm, mounting pad for collector 1 cm^2
(2) FR4 PCB 70 µm, mounting pad for collector 1 cm^2
(3) 4-layer PCB 70 µm, standard footprint
(4) 4-layer PCB 35 µm, mounting pad for collector 1 cm^2
(5) FR4 PCB 35 µm, mounting pad for collector 1 cm^2
(6) 4-layer PCB 35 µm, standard footprint
(7) FR4 PCB 70 µm, standard footprint
(8) FR4 PCB 35 µm, standard footprint

Fig. 1. Per transistor: power derating curves

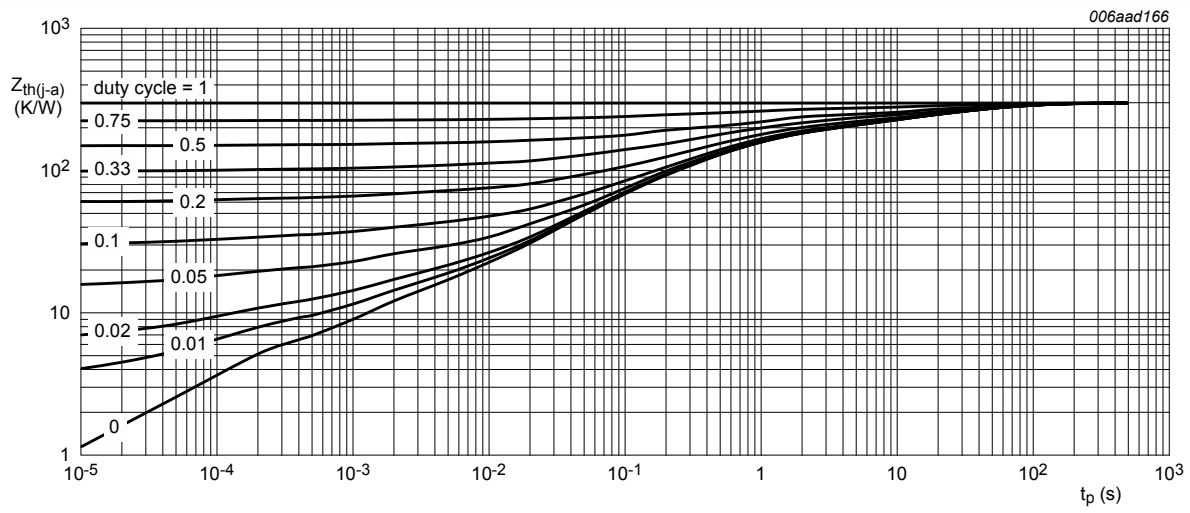
9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	338	K/W
			[2]	-	-	219	K/W
			[3]	-	-	236	K/W
			[4]	-	-	179	K/W
			[5]	-	-	278	K/W
			[6]	-	-	164	K/W
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	30	K/W

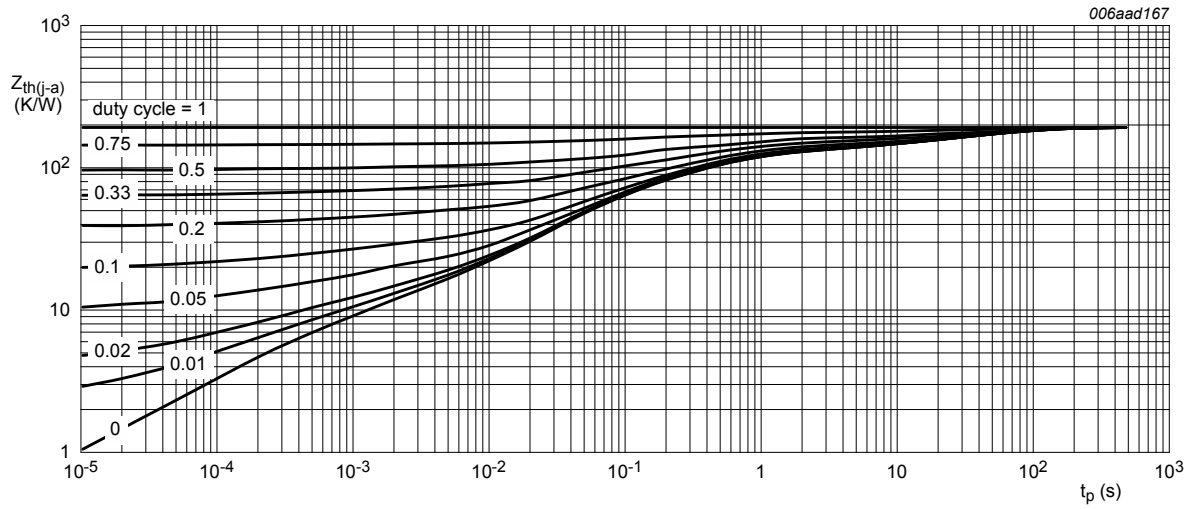
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per device							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	245	K/W
			[2]	-	-	160	K/W
			[3]	-	-	171	K/W
			[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
			[7]	-	-	130	K/W
			[8]	-	-	63	K/W

[1] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.
[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.
[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.
[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.
[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm^2.



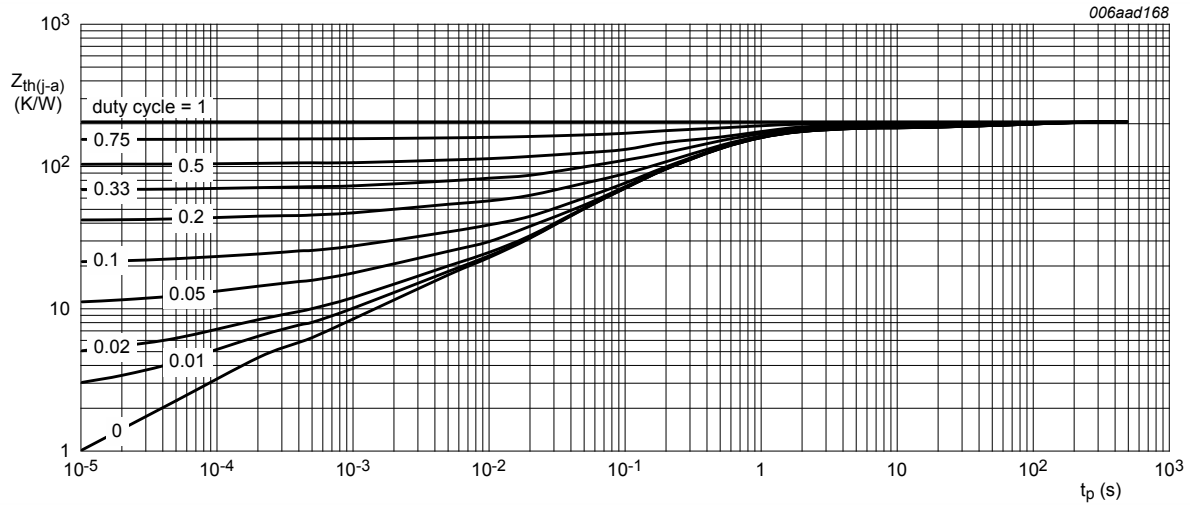
FR4 PCB 35 µm, standard footprint

Fig. 2. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



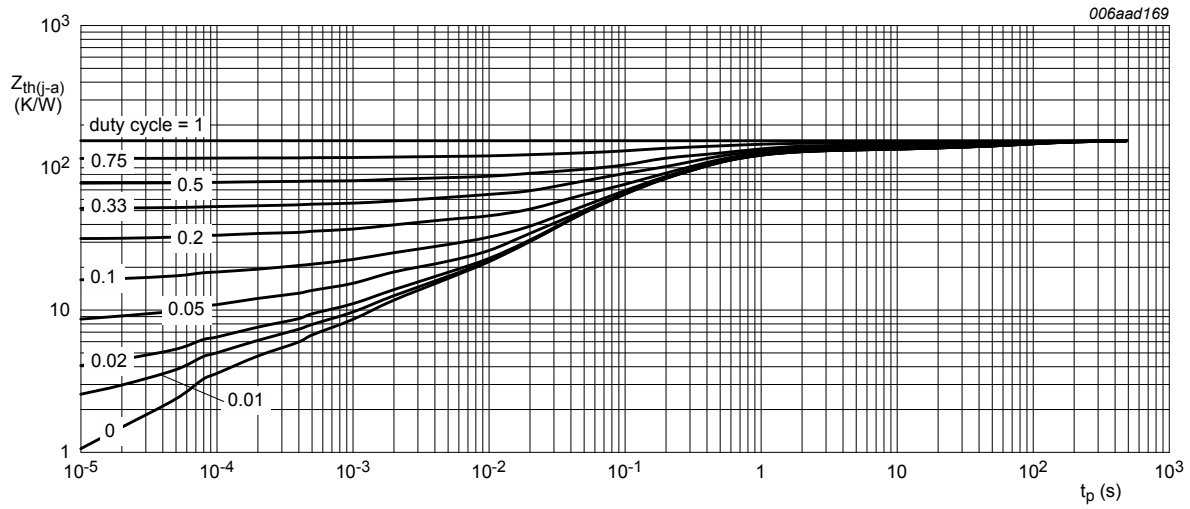
FR4 PCB 35 µm, mounting pad for collector 1 cm^2

Fig. 3. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



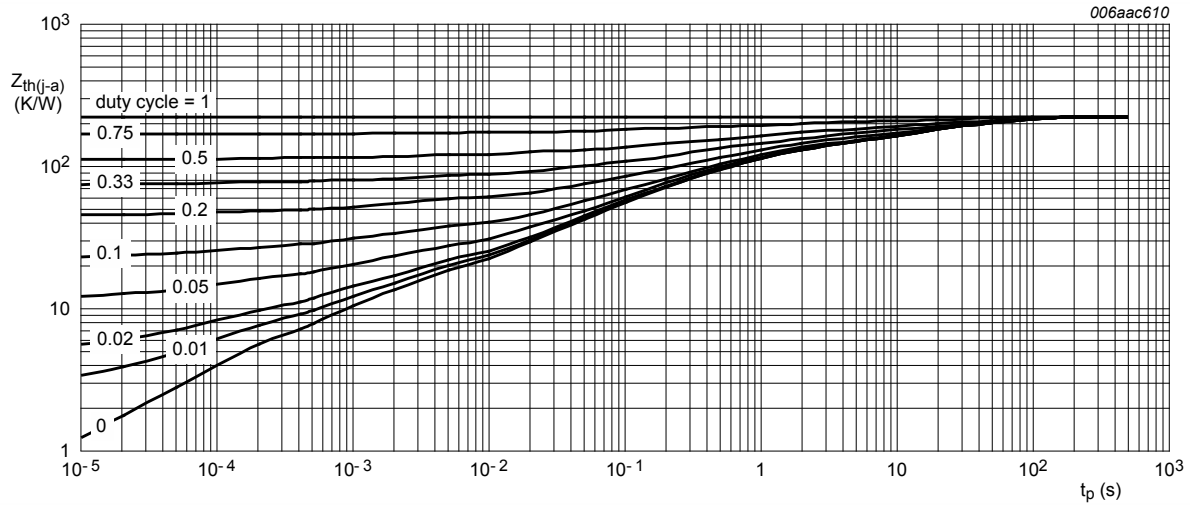
4-layer PCB 35 µm, standard footprint

Fig. 4. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



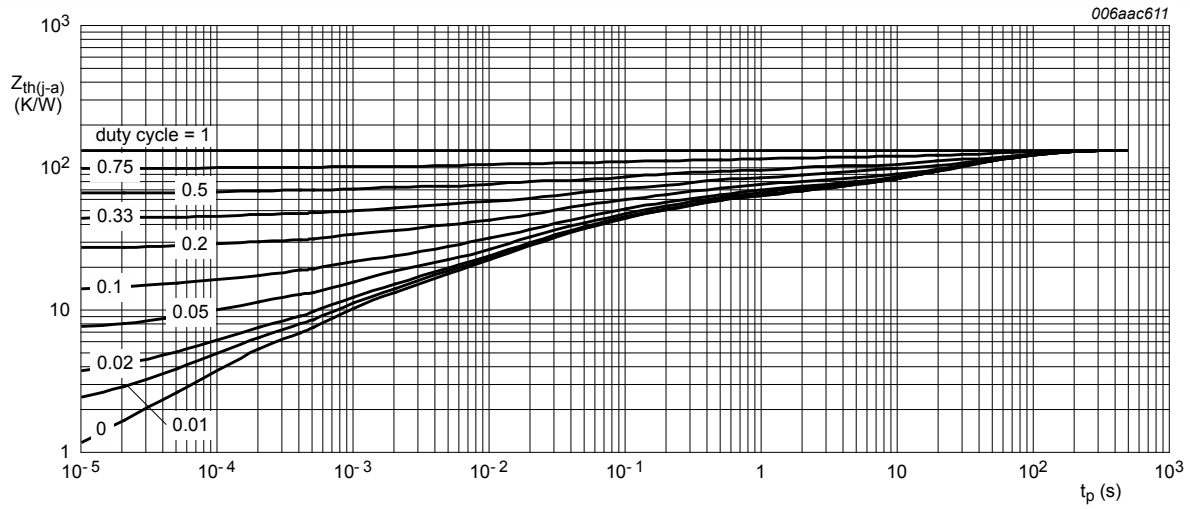
4-layer PCB 35 µm, mounting pad for collector 1 cm^2

Fig. 5. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



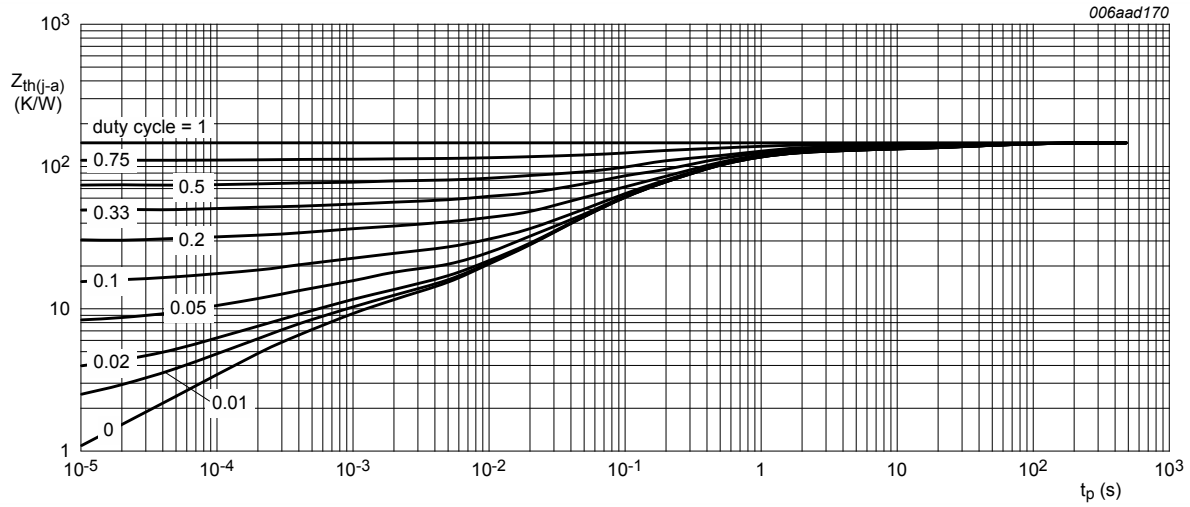
FR4 PCB 70 µm, standard footprint

Fig. 6. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



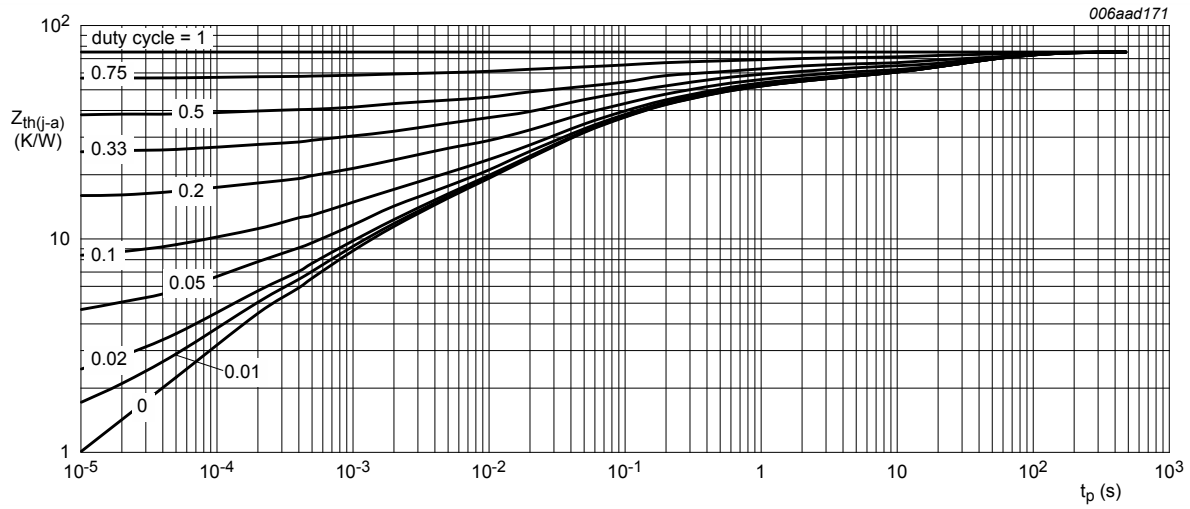
FR4 PCB 70 µm, mounting pad for collector 1 cm^2

Fig. 7. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



4-layer PCB 70 µm, standard footprint

Fig. 8. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values



4-layer PCB 70 µm, mounting pad for collector 1 cm^2

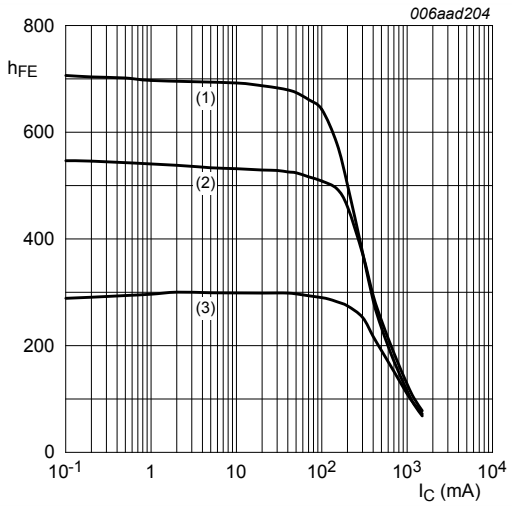
Fig. 9. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

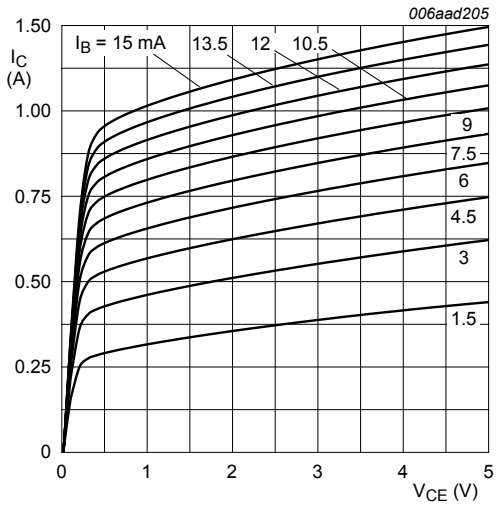
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
TR1 (NPN)							
I_{CBO}	collector-base cut-off current	V_{CB} = 48 V; I_E = 0 A; T_{amb} = 25 °C		-	-	100	nA
		V_{CB} = 48 V; I_E = 0 A; T_j = 150 °C		-	-	50	µA
I_{EBO}	emitter-base cut-off current	V_{EB} = 5 V; I_C = 0 A; T_{amb} = 25 °C		-	-	100	nA
h_{FE}	DC current gain	V_{CE} = 2 V; I_C = 100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		290	430	-	
		V_{CE} = 2 V; I_C = 500 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		150	220	-	
		V_{CE} = 2 V; I_C = 1 A; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		70	110	-	
V_{CEsat}	collector-emitter saturation voltage	I_C = 500 mA; I_B = 50 mA; T_{amb} = 25 °C		-	90	120	mV
		I_C = 1 A; I_B = 50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	185	240	mV
		I_C = 1 A; I_B = 100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	175	220	mV
R_{CEsat}	collector-emitter saturation resistance	I_C = 0.5 A; I_B = 50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	240	mΩ
V_{BEsat}	base-emitter saturation voltage	I_C = 500 mA; I_B = 50 mA; T_{amb} = 25 °C		-	-	1	V
		I_C = 1 A; I_B = 50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	1.1	V
		I_C = 1 A; I_B = 100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	1.1	V
V_{BEon}	base-emitter turn-on voltage	V_{CE} = 2 V; I_C = 0.5 A; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	0.9	V
t_d	delay time	V_{CC} = 10 V; I_C = 0.5 A; I_{Bon} = 25 mA; I_{Boff} = -25 mA; T_{amb} = 25 °C		-	15	-	ns
t_r	rise time			-	90	-	ns
t_{on}	turn-on time			-	105	-	ns
t_s	storage time			-	410	-	ns
t_f	fall time			-	130	-	ns
t_{off}	turn-off time			-	540	-	ns
f_T	transition frequency	V_{CE} = 10 V; I_C = 50 mA; f = 100 MHz; T_{amb} = 25 °C		90	175	-	MHz
C_c	collector capacitance	V_{CB} = 10 V; I_E = 0 A; i_e = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	4	6	pF
TR2 (PNP)							
I_{CBO}	collector-base cut-off current	V_{CB} = -48 V; I_E = 0 A		-	-	-100	nA
		V_{CB} = -48 V; I_E = 0 A; T_j = 150 °C		-	-	-50	µA
I_{EBO}	emitter-base cut-off current	V_{EB} = -5 V; I_C = 0 A		-	-	-100	nA

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
h_{FE}	DC current gain	V_{CE} = -2 V; I_C = -100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		170	245	-	
		V_{CE} = -2 V; I_C = -500 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		120	170	-	
		V_{CE} = -2 V; I_C = -1 A; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		70	100	-	
V_{CEsat}	collector-emitter saturation voltage	I_C = -500 mA; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-125	-180	mV
		I_C = -1 A; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-390	-550	mV
		I_C = -1 A; I_B = -100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-240	-340	mV
R_{CEsat}	collector-emitter saturation resistance	I_C = -0.5 A; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	360	mΩ
V_{BEsat}	base-emitter saturation voltage	I_C = -500 mA; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	-1	V
		I_C = -1 A; I_B = -50 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	-1	V
		I_C = -1 A; I_B = -100 mA; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	-1.1	V
V_{BEon}	base-emitter turn-on voltage	V_{CE} = -2 V; I_C = -0.5 A; $t_p \leq$ 300 µs; pulsed; δ ≤ 0.02 ; T_{amb} = 25 °C		-	-	-0.9	V
t_d	delay time	V_{CC} = -10 V; I_C = -0.5 A; I_{Bon} = -25 mA; I_{Boff} = 25 mA; T_{amb} = 25 °C		-	15	-	ns
t_r	rise time			-	40	-	ns
t_{on}	turn-on time			-	55	-	ns
t_s	storage time			-	95	-	ns
t_f	fall time			-	40	-	ns
t_{off}	turn-off time			-	135	-	ns
f_T	transition frequency	V_{CE} = -10 V; I_C = -50 mA; f = 100 MHz; T_{amb} = 25 °C		65	125	-	MHz
C_c	collector capacitance	V_{CB} = -10 V; I_E = 0 A; i_e = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	9.5	13	pF



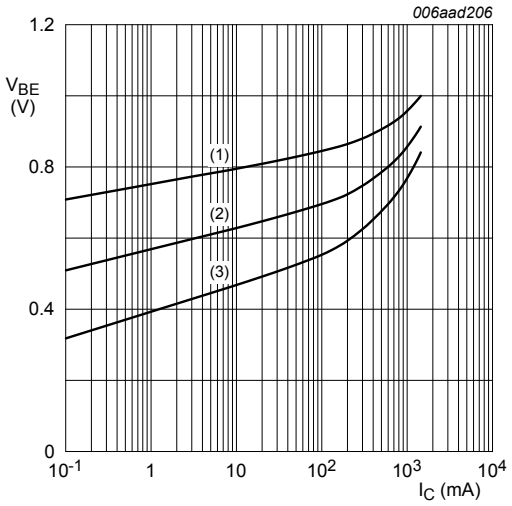
V_{CE} = 2 V
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 10. TR1 (NPN): DC current gain as a function of collector current; typical values



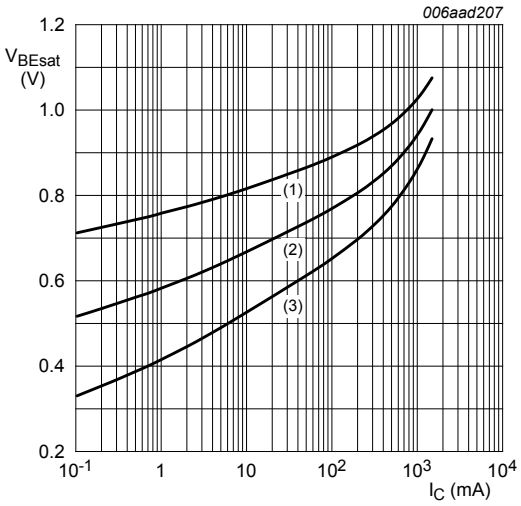
T_{amb} = 25 °C

Fig. 11. TR1 (NPN): Collector current as a function of collector-emitter voltage; typical values



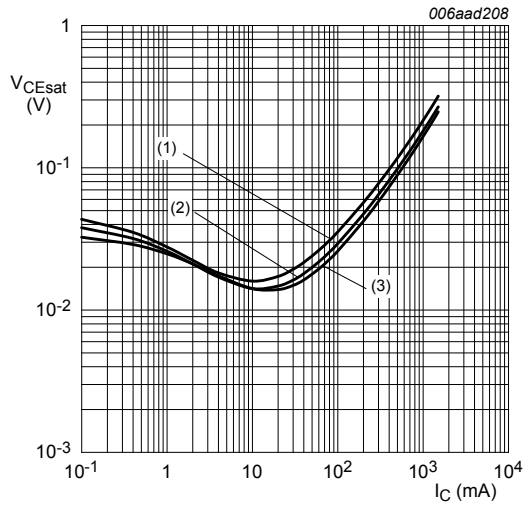
V_{CE} = 2 V
(1) T_{amb} = −55 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 100 °C

Fig. 12. TR1 (NPN): Base-emitter voltage as a function of collector current; typical values



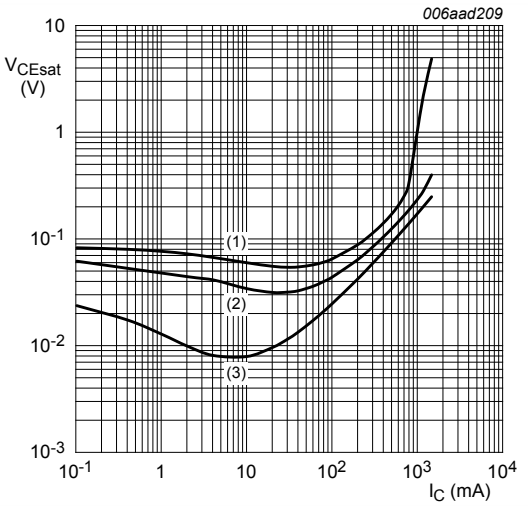
I_C/I_B = 20
(1) T_{amb} = −55 °C
(2) T_{amb} = 25 °C
(3) T_{amb}= 100 °C

Fig. 13. TR1 (NPN): Base-emitter saturation voltage as a function of collector current; typical values



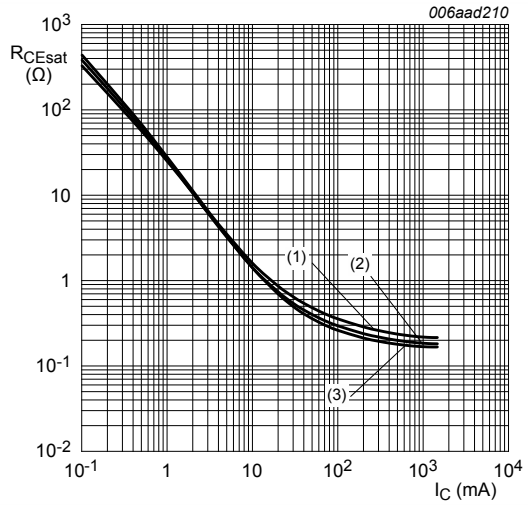
I_C/I_B = 20
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 14. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



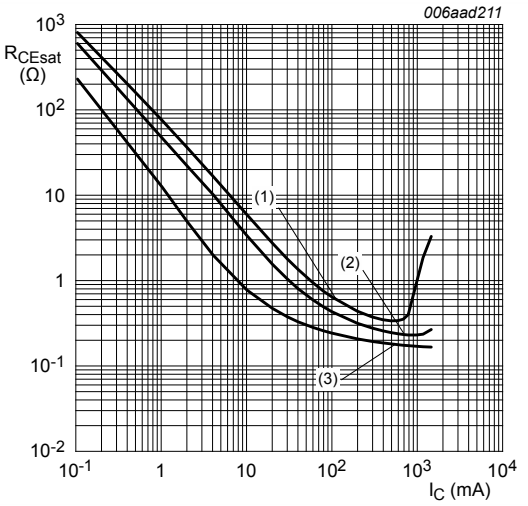
T_{amb} = 25 °C
(1) I_C/I_B = 100
(2) I_C/I_B = 50
(3) I_C/I_B = 10

Fig. 15. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



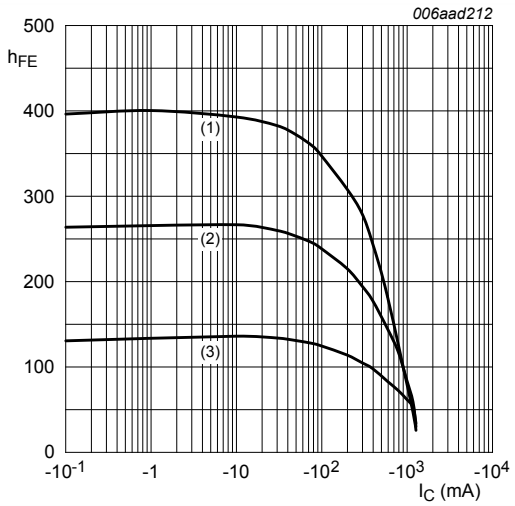
I_C/I_B = 20
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 16. TR1 (NPN): Collector-emitter saturation resistance as a function of collector current; typical values



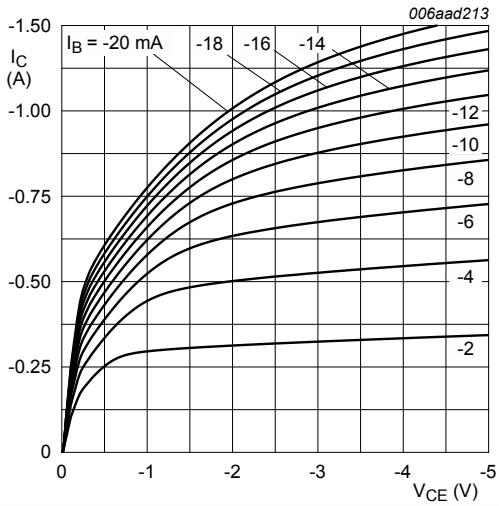
T_{amb} = 25 °C
(1) I_C/I_B = 100
(2) I_C/I_B = 50
(3) I_C/I_B = 10

Fig. 17. TR1 (NPN): Collector-emitter saturation resistance as a function of collector current; typical values



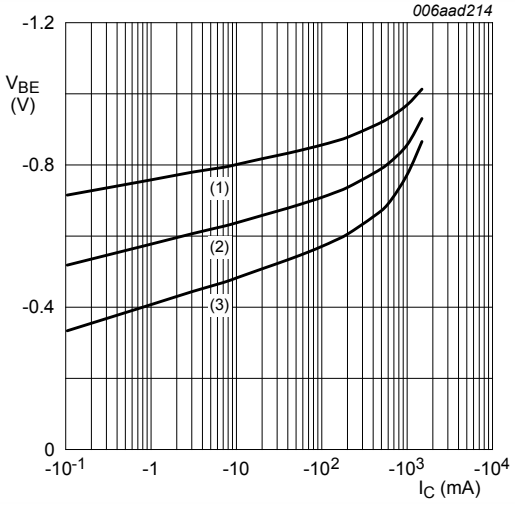
V_{CE} = −2 V
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 18. TR2 (PNP): DC current gain as a function of collector current; typical values



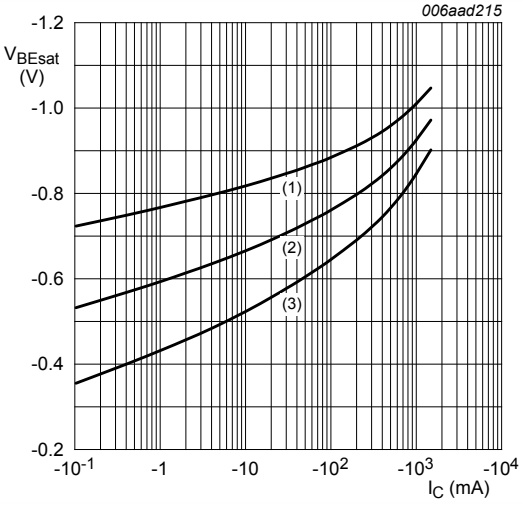
T_{amb} = 25 °C

Fig. 19. TR2 (PNP): Collector current as a function of collector-emitter voltage; typical values



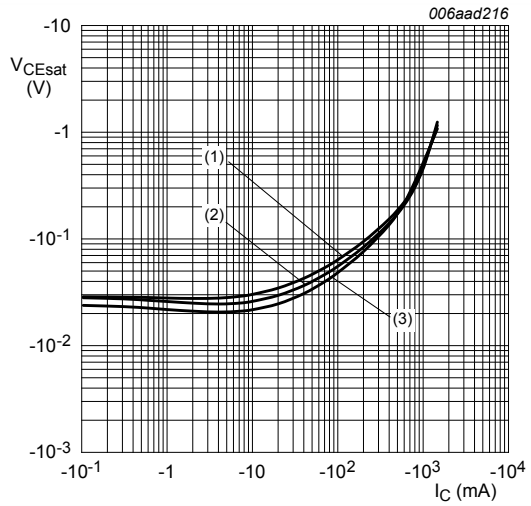
V_{CE} = −2 V
(1) T_{amb} = −55 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 100 °C

Fig. 20. TR2 (PNP): Base-emitter voltage as a function of collector current; typical values



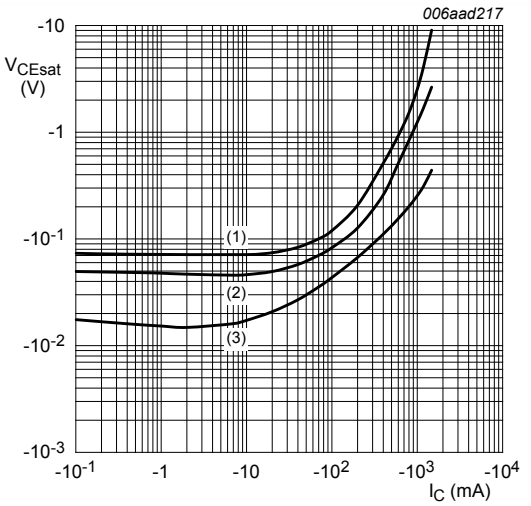
I_C/I_B = 20
(1) T_{amb} = −55 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = 100 °C

Fig. 21. TR2 (PNP): Base-emitter saturation voltage as a function of collector current; typical values



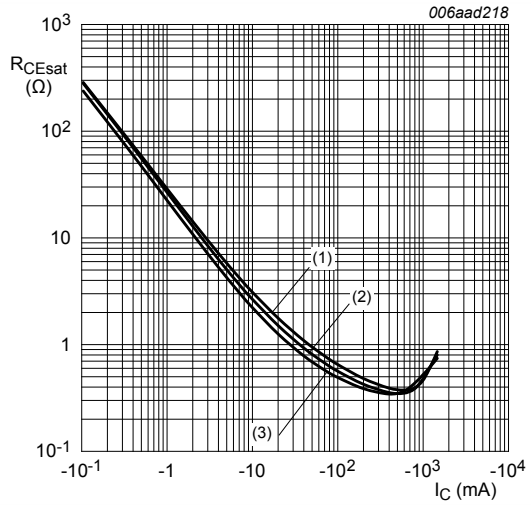
I_C/I_B = 20
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 22. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



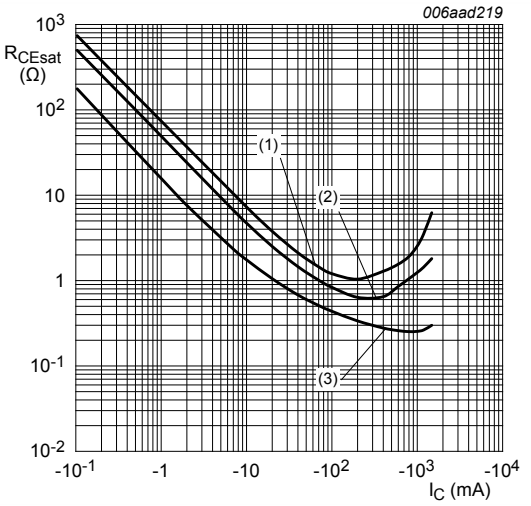
T_{amb} = 25 °C
(1) I_C/I_B = 100
(2) I_C/I_B = 50
(3) I_C/I_B = 10

Fig. 23. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



I_C/I_B = 20
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = −55 °C

Fig. 24. TR2 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values



T_{amb} = 25 °C
(1) I_C/I_B = 100
(2) I_C/I_B = 50
(3) I_C/I_B= 10

Fig. 25. TR2 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values

11. Test information

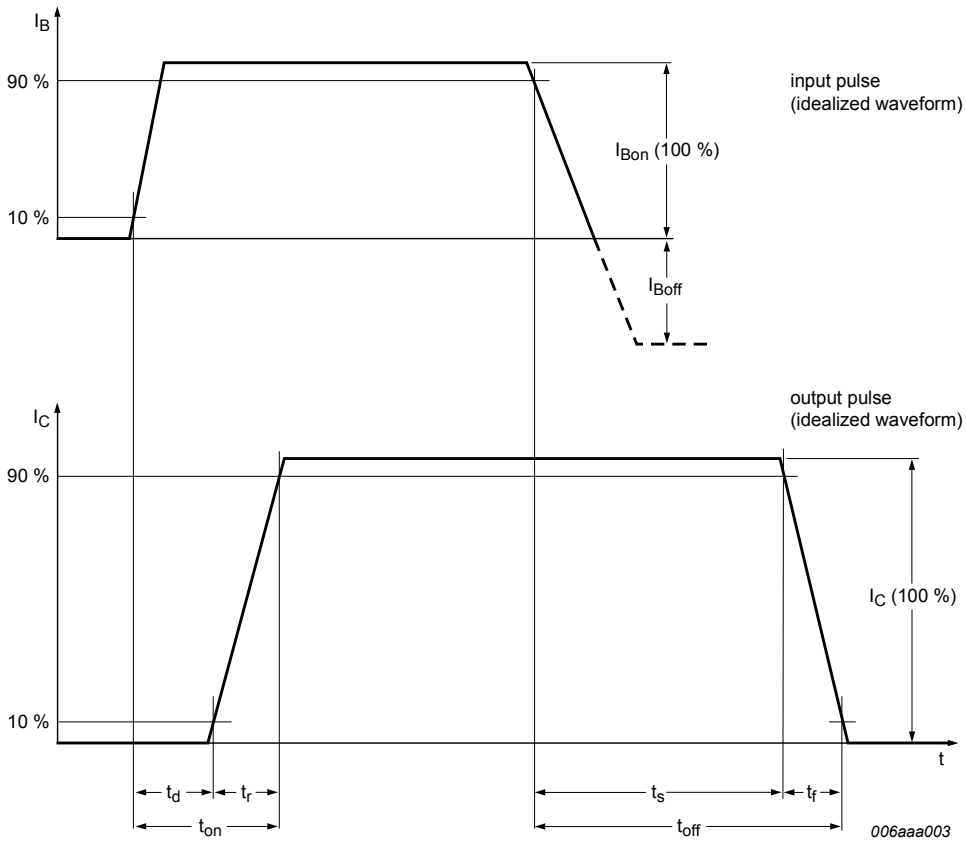


Fig. 26. TR1 (NPN): BISS transistor switching time definition

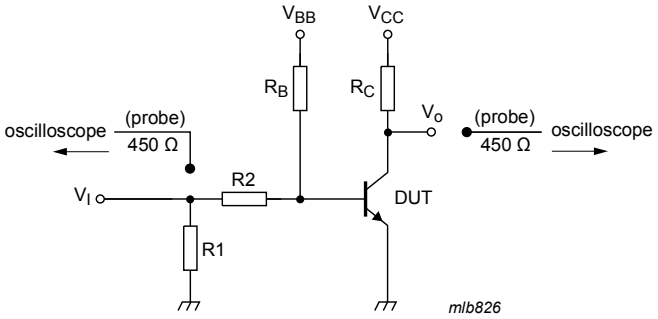


Fig. 27. TR1 (NPN): Test circuit for switching times

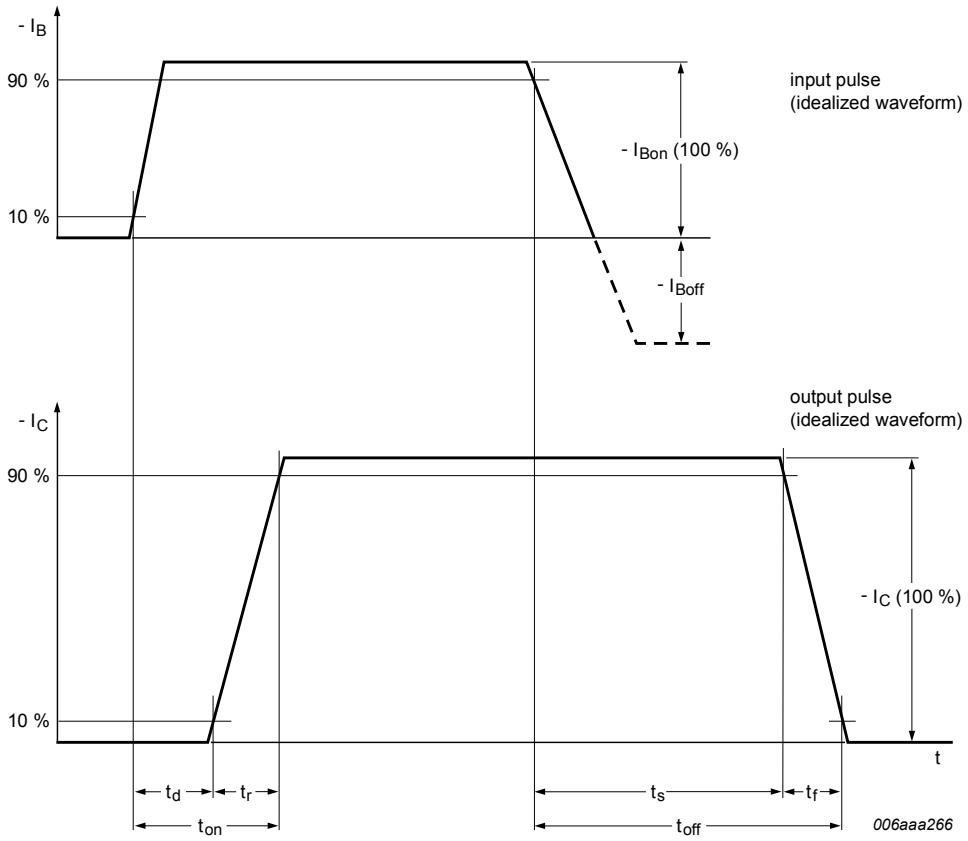


Fig. 28. TR2 (PNP): BISS transistor switching time definition

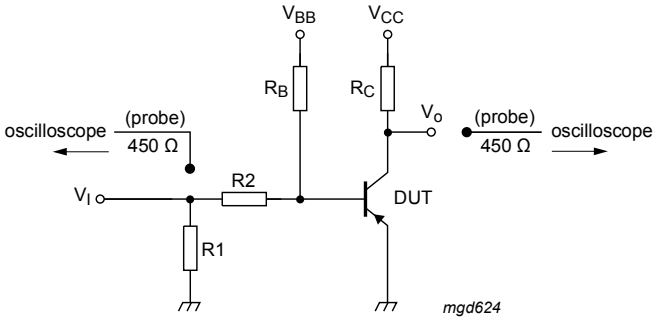


Fig. 29. TR2 (PNP): Test circuit for switching times

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

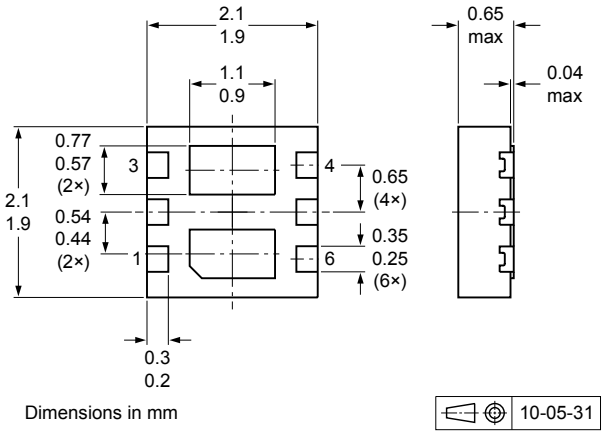


Fig. 30. Package outline DFN2020-6 (SOT1118)

13. Soldering

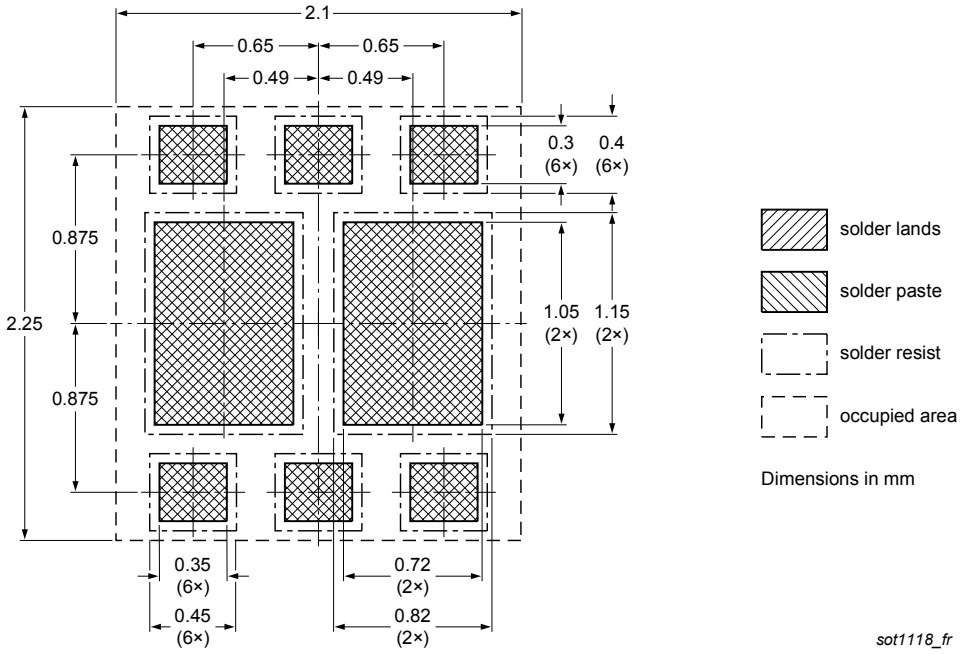


Fig. 31. Reflow soldering footprint for DFN2020-6 (SOT1118)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4160PANP v.2	20171220	Product data sheet	-	PBSS4160PANP v.1
Modifications:	• Characteristics: Fig. 22 corrected			
PBSS4160PANP v.1	20130114	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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16. Contents

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